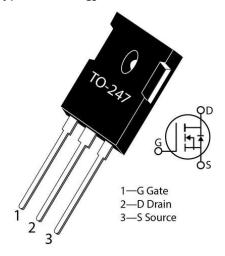
# **700V, 15 mΩ N-Channel mSiC<sup>™</sup> MOSFET**

**MSC015SMA070B** 



#### **Product Overview**

700V, 15 m $\Omega$  typical at 20 V<sub>GS</sub>, 18 m $\Omega$  typical at 18 V<sub>GS</sub>, Silicon Carbide (SiC) N-Channel MOSFET, TO-247.



#### **Features**

- Low capacitances and low gate charge
- Fast switching speed due to low internal gate resistance (ESR)
- Stable operation at high junction temperature, T<sub>I(max)</sub> = 175 °C
- · Fast and reliable body diode
- Superior avalanche ruggedness
- RoHS compliant

#### **Benefits**

- High efficiency to enable lighter and more compact system
- Simple to drive and easy to parallel
- Improved thermal capabilities and lower switching losses
- Eliminates the need for external freewheeling diode
- · Lower system cost of ownership

#### **Applications**

- Photovoltaic (PV) inverter, converter, and industrial motor drives
- Smart grid transmission and distribution
- · Induction heating and welding
- Hybrid Electric Vehicle (HEV) powertrain and Electric Vehicle (EV) charger
- Power supply and distribution

# 1. Device Specifications

This section shows the specifications of this device.

## 1.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings of this device.

Table 1-1. Absolute Maximum Ratings

| Symbol          | Parameter   | Ratings   | Unit |
|-----------------|---|-----------|------|
| $V_{DSS}$       | Drain source voltage                                | 700       | V    |
| I <sub>D</sub>  | Continuous drain current at T <sub>C</sub> = 25 °C  | 149       | Α    |
|                 | Continuous drain current at T <sub>C</sub> = 100 °C | 106       |      |
| I <sub>DM</sub> | Pulsed drain current <sup>1</sup>                   | 350       |      |
| $V_{GS}$        | Gate-source voltage                                 | 23 to -10 | V    |
|                 | Transient gate-source voltage                       | 25 to -12 |      |
| P <sub>D</sub>  | Total power dissipation at T <sub>C</sub> = 25 °C   | 524       | W    |
|                 | Linear derating factor                              | 3.5       | W/°C |

#### Note:

1. Repetitive rating: pulse width and case temperature are limited by the maximum junction temperature.

The following table shows the thermal and mechanical characteristics of this device.

**Table 1-2.** Thermal and Mechanical Characteristics

| Symbol           | Characteristic/Test Conditions      | Min. | Тур. | Max. | Unit   |
|------------------|-------------------------------------|------|------|------|--------|
| $R_{\theta JC}$  | Junction-to-case thermal resistance | _    | 0.22 | 0.29 | °C/W   |
| T <sub>J</sub>   | Operating junction temperature      | -55  | _    | 175  | °C     |
| T <sub>STG</sub> | Storage temperature                 | -55  | _    | 150  | °C     |
| TL               | Lead temperature for 10 seconds     | _    | _    | 300  | °C     |
| _                | Mounting torque, 6-32 or M3 screw   | _    | _    | 10   | lbf.in |
|                  |                                     | _    | _    | 1.1  | N.m    |
| Wt               | Package weight                      | _    | 0.22 | _    | OZ     |
|                  |                                     | _    | 6.2  | _    | g      |

ESD practices should comply with JESD-625.

### 1.2 Electrical Performance

The following table shows the static characteristics of this device.  $T_J = 25$  °C unless otherwise specified.

Table 1-3. Static Characteristics

| Symbol               | Characteristic                          | Test Conditions                                    | Min. | Тур. | Max. | Unit |
|----------------------|---|--|------|------|------|------|
| V <sub>(BR)DSS</sub> | Drain-source breakdown voltage          | $V_{GS} = 0V, I_D = 100 \mu A$                     | 700  | _    | _    | V    |
| R <sub>DS(on)</sub>  | Drain-source on resistance <sup>1</sup> | $V_{GS} = 20V, I_D = 40A$                          | _    | 15   | 19   | mΩ   |
|                      |   | $V_{GS} = 18V$ , $I_{D} = 40A$                     | _    | 18   | _    |      |
| V <sub>GS(th)</sub>  | Gate-source threshold voltage           | $V_{GS} = V_{DS}$ , $I_D = 4 \text{ mA}$           | 1.9  | 3.0  | _    | V    |
| I <sub>DSS</sub>     | Zero gate voltage drain current         | $V_{DS} = 700V, V_{GS} = 0V$                       | _    | 0.3  | 40   | μΑ   |
|                      |   | $V_{DS} = 700V$ , $V_{GS} = 0V$ , $T_{J} = 175$ °C | _    | 3.5  | _    |      |
| I <sub>GSS</sub>     | Gate-source leakage current             | V <sub>GS</sub> = 20V/-10V                         | _    | _    | ±100 | nA   |



#### Note:

1. Pulse test: pulse width < 380  $\mu$ s, duty cycle < 2%.

The following table shows the dynamic characteristics of this device.  $T_J$  = 25 °C unless otherwise specified. The dynamic characteristics are characterized, not 100% tested, at the recommended operating  $V_{GS}$  = 20V/–5V.

**Table 1-4.** Dynamic Characteristics

| Symbol              | Characteristic                    | Test Conditions   | Min. | Тур. | Max. | Unit |
|---------------------|-----------------------------------|---|------|------|------|------|
| C <sub>iss</sub>    | Input capacitance                 | $V_{GS} = 0V$   | _    | 4500 | _    | pF   |
| C <sub>rss</sub>    | Reverse transfer capacitance      | V <sub>DD</sub> = 700V                                      | _    | 44   | _    |      |
| C <sub>oss</sub>    | Output capacitance                | $V_{AC} = 25 \text{ mV}$<br>f = 200 kHz                     | _    | 510  | _    |      |
| Qg                  | Total gate charge                 | V <sub>GS</sub> = -5V/20V                                   | _    | 215  | _    | nC   |
| $Q_{gs}$            | Gate-source charge                | V <sub>DD</sub> = 470V                                      | _    | 58   | _    |      |
| $Q_{gd}$            | Gate-drain charge                 | I <sub>D</sub> = 40A  | _    | 35   | _    |      |
| t <sub>d(on)</sub>  | Turn-on delay time                | V <sub>DD</sub> = 470V                                      | _    | 25   | _    | ns   |
| t <sub>r</sub>      | Voltage rise time                 | $V_{GS} = -5V/20V$  | _    | 34   | _    |      |
| t <sub>d(off)</sub> | Turn-off delay time               | $I_D = 40A$   | _    | 53   | _    |      |
| t <sub>f</sub>      | Voltage fall time                 | $R_{g(ext)} = 4\Omega$                                      | _    | 20   | _    |      |
| E <sub>on</sub>     | Turn-on switching energy          | Freewheeling diode = MSC015SMA070B (V <sub>GS</sub> = -5V); | _    | 856  | _    | μJ   |
| E <sub>off</sub>    | Turn-off switching energy         | reference Figure 1-18                                       | _    | 129  | _    |      |
| ESR                 | Gate equivalent series resistance | f = 1 MHz, 25 mV, drain short                               | _    | 0.69 | _    | Ω    |
| SCWT                | Short circuit withstand time      | V <sub>DS</sub> = 560V, V <sub>GS</sub> = 20V               | _    | 3    | _    | μs   |
| E <sub>AS</sub>     | Avalanche energy, single pulse    | I <sub>D</sub> = 40A  | _    | 4400 | _    | mJ   |

The following table shows the body diode characteristics of this device.  $T_J$  = 25 °C unless otherwise specified.

Table 1-5. Body Diode Characteristics

| Symbol           | Characteristic           | Test Conditions  | Min. | Тур. | Max. | Unit |
|------------------|--------------------------|--|------|------|------|------|
| $V_{SD}$         | Diode forward voltage    | $I_{SD} = 40A$ , $V_{GS} = 0V$                                   | _    | 3.4  | _    | V    |
|                  |                          | $I_{SD} = 40A$ , $V_{GS} = -5V$                                  | _    | 3.8  | _    |      |
| t <sub>rr</sub>  | Reverse recovery time    | $I_{SD}$ = 40A, $V_{GS}$ = -5V, $V_{DD}$ = 470V, $dI/dt$ = -1200 | _    | 40   | _    | ns   |
| Q <sub>rr</sub>  | Reverse recovery charge  | A/μs   | _    | 495  | _    | nC   |
| I <sub>RRM</sub> | Reverse recovery current |  | _    | 19   | _    | Α    |



## 1.3 Typical Performance Curves

Data for performance curves are characterized, not 100% tested.

Figure 1-1. Drain Current vs.  $V_{DS}$  at  $T_J$ 

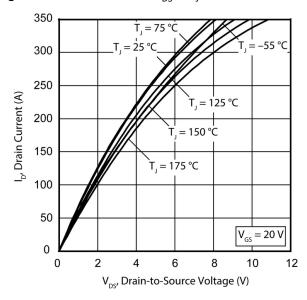


Figure 1-2. Drain Current vs.  $V_{DS}$  at  $V_{GS}$ 

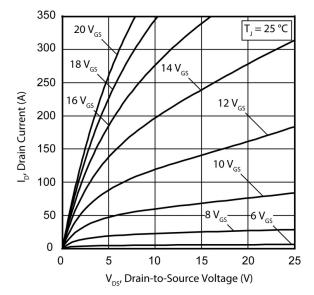


Figure 1-3. Drain Current vs.  $V_{DS}$  at  $V_{GS}$ 

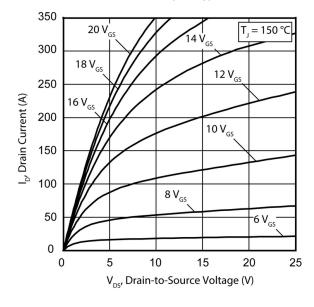


Figure 1-4. Drain Current vs. V<sub>DS</sub> at V<sub>GS</sub>

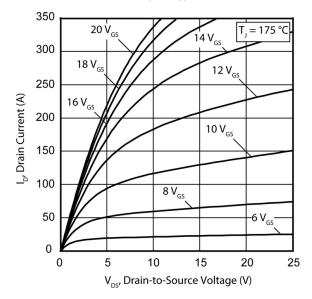




Figure 1-5. R<sub>DS(on)</sub> vs. Junction Temperature

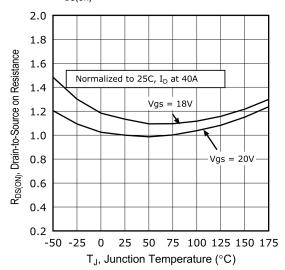


Figure 1-6. Gate Charge Characteristics

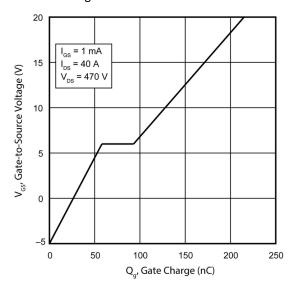


Figure 1-7. Capacitance vs. Drain-to-Source Voltage

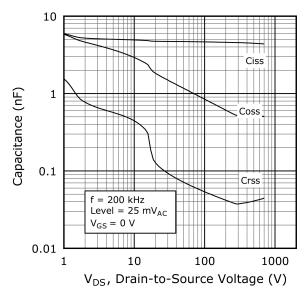


Figure 1-8. Output Charge vs. Drain-to-Source Voltage

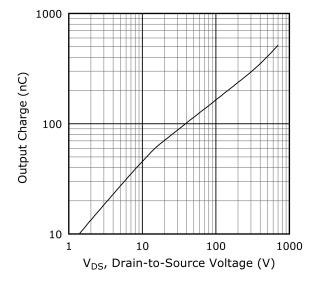




Figure 1-9.  $I_D$  vs.  $V_{DS}$  3<sup>rd</sup> Quadrant Conduction

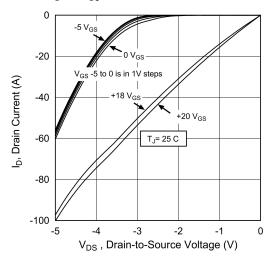
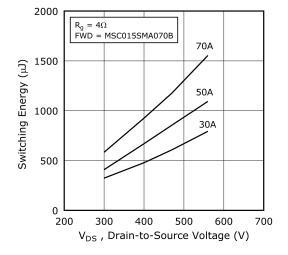


Figure 1-11. Switching Energy Eon vs.  $V_{DS} \& I_{D}$ 



**Figure 1-10.**  $I_D$  vs.  $V_{DS}$   $3^{rd}$  Quadrant Conduction

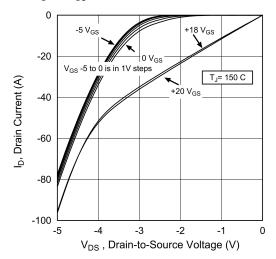


Figure 1-12. Switching Energy Eoff vs.  $V_{DS} \& I_{D}$ 

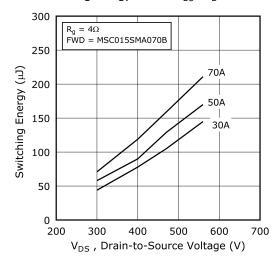




Figure 1-13. Switching Energy vs. R<sub>g</sub>

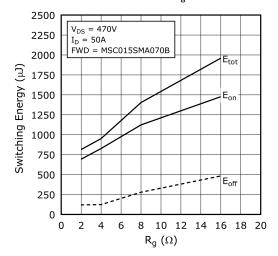


Figure 1-14. Switching Energy vs. Junction Temperature

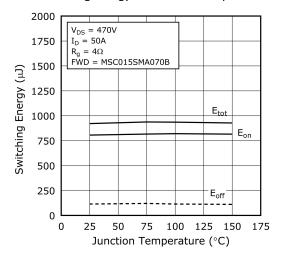
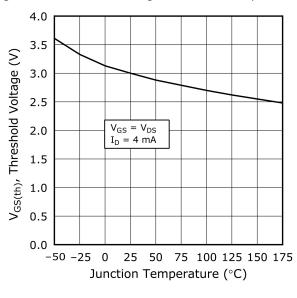
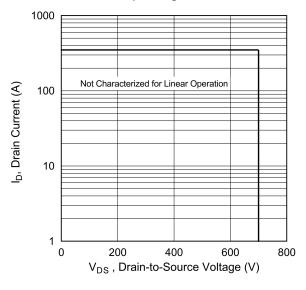


Figure 1-15. Threshold Voltage vs. Junction Temperature Figure 1-16. Forward Safe Operating Area



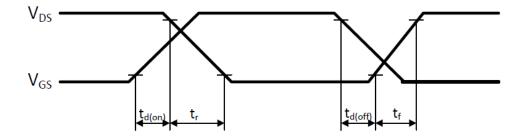


0.1 D = 0.9 O.7 O.5 O.5 Single Pulse Duty Factor D = \(^{t\_1}/\_{t\_2}\)
Duty Factor D = \(^{t\_1}/\_{t\_2}\)
PeakT J = P DM x Z \(\text{BIC}\) + T C
Pulse Duration (seconds)

Figure 1-17. Maximum Transient Thermal Impedance

The following figure shows the switching waveform diagram of this device.

Figure 1-18. Switching Waveform





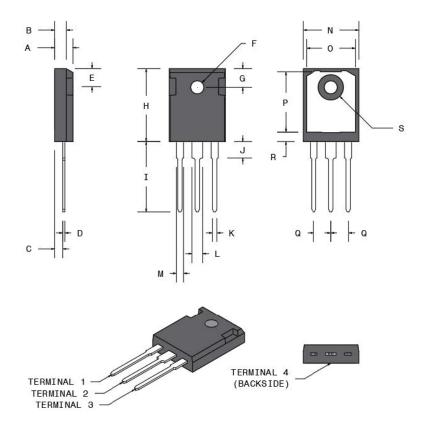
# 2. Package Specification

This section shows the package specification of this device.

# 2.1 Package Outline Drawing

The following figure illustrates the TO-247 package outline of this device.

Figure 2-1. Package Outline Drawing



The following table shows the TO-247 dimensions and must be used in conjunction with the package outline drawing.

Table 2-1. TO-247 Dimensions

| Symbol | Min. (mm) | Max. (mm) | Min. (in.) | Max. (in.) |
|--------|-----------|-----------|------------|------------|
| A      | 4.69      | 5.31      | 0.185      | 0.209      |
| В      | 1.49      | 2.49      | 0.059      | 0.098      |
| С      | 2.21      | 2.59      | 0.087      | 0.102      |
| D      | 0.40      | 0.79      | 0.016      | 0.031      |
| E      | 5.38      | 6.20      | 0.212      | 0.244      |
| F      | 3.50      | 3.81      | 0.138      | 0.150      |
| G      | 6.15 BSC  |           | 0.242 BSC  |            |
| Н      | 20.80     | 21.46     | 0.819      | 0.845      |
| I      | 19.81     | 20.32     | 0.780      | 0.800      |
| J      | 4.00      | 4.50      | 0.157      | 0.177      |
| K      | 1.01      | 1.40      | 0.040      | 0.055      |
| L      | 2.87      | 3.12      | 0.113      | 0.123      |



| continued  |           |           |            |            |
|------------|-----------|-----------|------------|------------|
| Symbol     | Min. (mm) | Max. (mm) | Min. (in.) | Max. (in.) |
| M          | 1.65      | 2.13      | 0.065      | 0.084      |
| N          | 15.49     | 16.26     | 0.610      | 0.640      |
| 0          | 13.50     | 14.50     | 0.531      | 0.571      |
| P          | 16.50     | 17.50     | 0.650      | 0.689      |
| Q          | 5.45 BSC  |           | 0.215 BSC  |            |
| R          | 2.00      | 2.75      | 0.079      | 0.108      |
| S          | 7.10      | 7.50      | 0.280      | 0.295      |
| Terminal 1 | Gate      |           |            |            |
| Terminal 2 | Drain     |           |            |            |
| Terminal 3 | Source    |           |            |            |
| Terminal 4 | Drain     |           |            |            |

# 3. Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

Table 3-1. Revision History

| Revision   | Date            | Description   |
|--|-----------------|---|
| В  | 09/2023         | The following changes are made in this revision of the document:  |
|  |                 | Updated the maximum value for the lead<br>temperature in the Table 1-2.   |
|  |                 | Added Figure 1-8, Figure 1-9, Figure 1-10, and Figure 1-18.   |
|  |                 | • Updated Figure 1-5 and Figure 1-16.   |
|  |                 | Corrected the initial releases row of the revision<br>history table to show accurate revisions and<br>release dates of Microsemi versions of this data<br>sheet.                      |
| A  | 05/2023         | Document migrated from Microsemi template to Microchip template; Assigned Microchip literature number DS-00004985A, which replaces the previous Microsemi literature number 050-7746. |
| Initial releases (Microsemi Revisions A, B, and C) | 03/2019-09/2020 | Initial releases.   |



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| el: 774-760-0087         | Tel: 86-25-8473-2460  | Tel: 60-4-227-8870      | Germany - Karlsruhe                                |
| ax: 774-760-0088         | China - Qingdao       | Philippines - Manila    | Tel: 49-721-625370                                 |
| hicago                   | Tel: 86-532-8502-7355 | Tel: 63-2-634-9065      | Germany - Munich                                   |
| asca, IL                 | China - Shanghai      | Singapore               | Tel: 49-89-627-144-0                               |
| el: 630-285-0071         | Tel: 86-21-3326-8000  | Tel: 65-6334-8870       | Fax: 49-89-627-144-44                              |
| ax: 630-285-0075         | China - Shenyang      | Taiwan - Hsin Chu       | Germany - Rosenheim                                |
| allas                    | Tel: 86-24-2334-2829  | Tel: 886-3-577-8366     | Tel: 49-8031-354-560                               |
| ddison, TX               | China - Shenzhen      | Taiwan - Kaohsiung      | Israel - Ra'anana                                  |
| el: 972-818-7423         | Tel: 86-755-8864-2200 | Tel: 886-7-213-7830     | Tel: 972-9-744-7705                                |
| ax: 972-818-2924         | China - Suzhou        | Taiwan - Taipei         | Italy - Milan                                      |
| etroit                   | Tel: 86-186-6233-1526 | Tel: 886-2-2508-8600    | Tel: 39-0331-742611                                |
| ovi, MI                  | China - Wuhan         | Thailand - Bangkok      | Fax: 39-0331-466781                                |
| el: 248-848-4000         | Tel: 86-27-5980-5300  | Tel: 66-2-694-1351      | Italy - Padova                                     |
| ouston, TX               | China - Xian          | Vietnam - Ho Chi Minh   | Tel: 39-049-7625286                                |
| el: 281-894-5983         | Tel: 86-29-8833-7252  | Tel: 84-28-5448-2100    | Netherlands - Drunen                               |
| idianapolis              | China - Xiamen        | 101. 04 20 3440 2100    | Tel: 31-416-690399                                 |
| oblesville, IN           | Tel: 86-592-2388138   |                         | Fax: 31-416-690340                                 |
| el: 317-773-8323         | China - Zhuhai        |                         | Norway - Trondheim                                 |
| ax: 317-773-5453         | Tel: 86-756-3210040   |                         | Tel: 47-72884388                                   |
| el: 317-536-2380         | Tel. 80-730-3210040   |                         | Poland - Warsaw                                    |
| os Angeles               |                       |                         | Tel: 48-22-3325737                                 |
| lission Viejo, CA        |                       |                         | Romania - Bucharest                                |
| el: 949-462-9523         |                       |                         | Tel: 40-21-407-87-50                               |
| ax: 949-462-9608         |                       |                         | Spain - Madrid                                     |
| el: 951-273-7800         |                       |                         | Tel: 34-91-708-08-90                               |
|                          |                       |                         | Fax: 34-91-708-08-91                               |
| aleigh, NC               |                       |                         |  |
| el: 919-844-7510         |                       |                         | <b>Sweden - Gothenberg</b><br>Tel: 46-31-704-60-40 |
| ew York, NY              |                       |                         |  |
| el: 631-435-6000         |                       |                         | Sweden - Stockholm                                 |
| an Jose, CA              |                       |                         | Tel: 46-8-5090-4654                                |
| el: 408-735-9110         |                       |                         | UK - Wokingham                                     |
| el: 408-436-4270         |                       |                         | Tel: 44-118-921-5800                               |
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